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Part I

Special Issue

Knowledge Building in Materials Science

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Part II

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The International Journal of ENGINEERING EDUCATION

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The International Journal of ENGINEERING EDUCATION

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Ball *et al.*—Working on an assignment with people you'll never meet!-Case study on learning operations management in international teams

Mayor, Pinto, Campos—Slug Flow Simulator—A tool for the teaching and learning two-phase slug flow regime in vertical columns

Palmer *et al.*—What is the On-campus Experience? Engineering Student Study and Work

Moreti *et al.*—Using an Engineering Design Problem to Assess Attainment of Life-Long Learning

Lamkin-Kennard *et al.*—Teaching Biomedical Engineering Ethics in the Context of Statistics

Lindsay *et al.*—A Different Kind of Difference: Theoretical Implications of Using Technology to Overcome Separation in Remote Laboratories

Badal *et al.*—An Integrated Database Approach for Managing Educational Resources in Agricultural and Biological Engineering

King, Collins—Ethical and Professional Training of Biomedical Engineers at Vanderbilt University

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